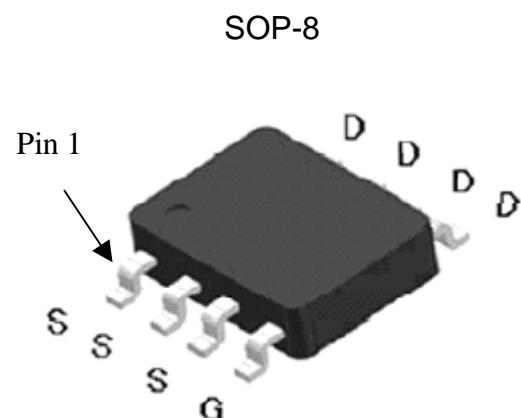


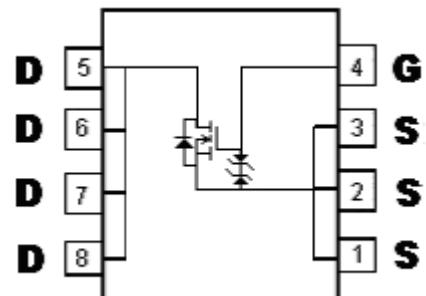
N-Channel Enhancement Mode Power MOSFET

Features:

- Single Drive Requirement
- Low On-resistance
- Fast Switching Characteristic
- ESD protected gate
- Pb-free & Halogen-free package



BV_{DSS}	60V
I_d @ T_A=25°C, V_{GS}=10V	9.3A
R_{D(S)}(ON)@V_{GS}=10V, I_d=8A	13.1 mΩ (typ)
R_{D(S)}(ON)@V_{GS}=4.5V, I_d=6A	15.9 mΩ (typ)
R_{D(S)}(ON)@V_{GS}=4V, I_d=4A	17.2 mΩ (typ)



G : Gate

D : Drain

S : Source

Ordering Information

Device	Package	Shipping
KWB20N06KQ8	SOP-8 (Pb-free lead plating and halogen-free package)	2500 pcs / tape & reel

Absolute Maximum Ratings (T_c=25°C, unless otherwise noted)

Parameter	Symbol	Limits	Unit
Drain-Source Voltage	V _{DS}	60	V
Gate-Source Voltage	V _{GS}	±20	
Continuous Drain Current @ T _A =25°C, V _{GS} =10V	I _D	9.3	A
Continuous Drain Current @ T _A =70°C, V _{GS} =10V		7.4	
Pulsed Drain Current	I _{DM}	40 *1	
Single Pulse Avalanche Current	I _{AS}	9.3	
Avalanche Energy @ L=2mH, I _d =9.3A, V _{DD} =15V	E _{AS}	86	mJ
Total Power Dissipation	T _A =25 °C	3.1	W
	T _A =70 °C	2	
Operating Junction and Storage Temperature	T _j , T _{stg}	-55~+150	°C

Note : *1. Pulse width limited by maximum junction temperature

*2. Duty cycle ≤ 1%

Thermal Data

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-case	R _{θJC}	8	°C/W
Thermal Resistance, Junction-to-ambient (Note)	R _{θJA}	40	

Note : When mounted on a 1 in² pad of 2 oz copper, t≤10s; 125 °C/W when mounted on minimum pad.

Characteristics (T_c=25°C, unless otherwise specified)

Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Static					
BV _{DSS}	60	-	-	V	V _{GS} =0V, I _D =250μA
V _{GS(th)}	1.2	-	2.5		V _{DS} = V _{GS} , I _D =250μA
G _{FS}	-	17	-	S	V _{DS} = 5V, I _D =8A
I _{GSS}	-	-	±10	μA	V _{GS} =±16V
I _{DSS}	-	-	1		V _{DS} = 60V, V _{GS} = 0V
	-	-	25		V _{DS} = 48V, V _{GS} = 0V, T _j =85°C
*R _{DSS(ON)}	-	13.1	17	mΩ	V _{GS} = 10V, I _D =8A
	-	15.9	21		V _{GS} = 4.5V, I _D =6A
	-	17.2	26		V _{GS} = 4V, I _D =4A
Dynamic					
Q _g *1, 2	-	18.5	-	nC	V _{DS} =48V, I _D =9.3A, V _{GS} =10V
Q _{gs} *1, 2	-	1.9	-		
Q _{gd} *1, 2	-	6.5	-		
C _{iss}	-	736	-	pF	V _{DS} =20V, V _{GS} =0V, f=1MHz
C _{oss}	-	140	-		
C _{rss}	-	70	-		

Characteristics (Cont. T_c=25°C, unless otherwise specified)

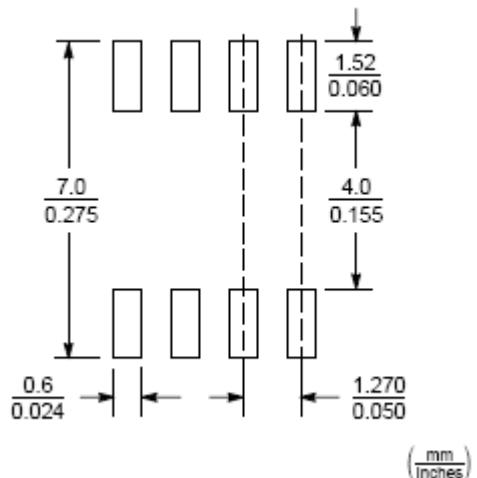
Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Dynamic					
t _{d(ON)} *1, 2	-	8.6	-	ns	V _{DS} =30V, I _D =1A, V _{GS} =10V, R _G =6Ω
t _r *1, 2	-	17.6	-		
t _{d(OFF)} *1, 2	-	39.8	-		
t _f *1, 2	-	20	-		
Source-Drain Diode Ratings and Characteristics					
I _S *1	-	-	4	A	Is=4A, V _{GS} =0V
I _{SM} *3	-	-	16		
V _{SD} *1	-	0.79	1.2	V	Is=4A, V _{GS} =0V
t _{rr}	-	14	-	ns	I _F =4A, dI _F /dt=100A/μs
Q _{rr}	-	10	-	nC	

Note : *1.Pulse Test : Pulse Width ≤300μs, Duty Cycle≤2%

*2.Independent of operating temperature

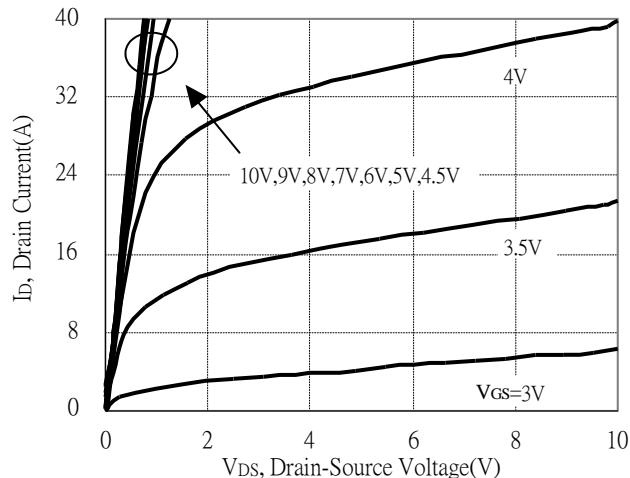
*3.Pulse width limited by maximum junction temperature.

Recommended Soldering Footprint

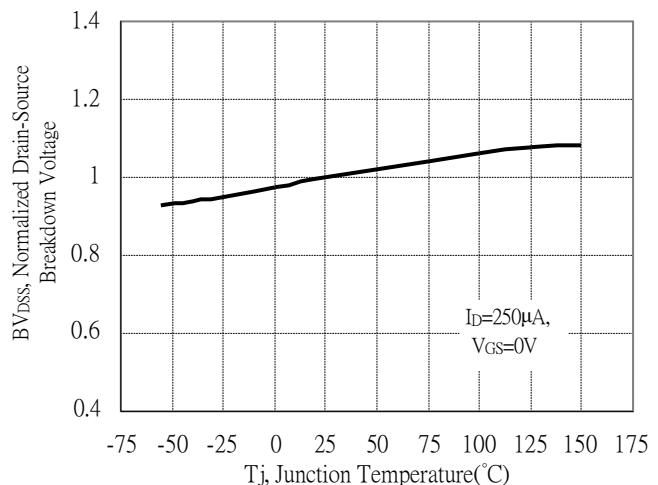


Typical Characteristics

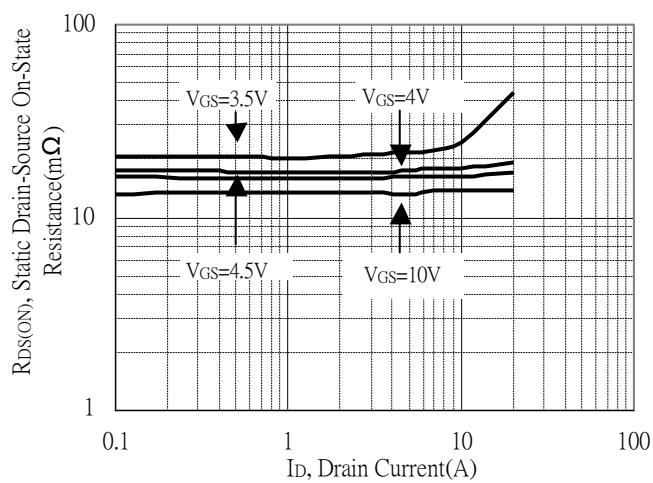
Typical Output Characteristics



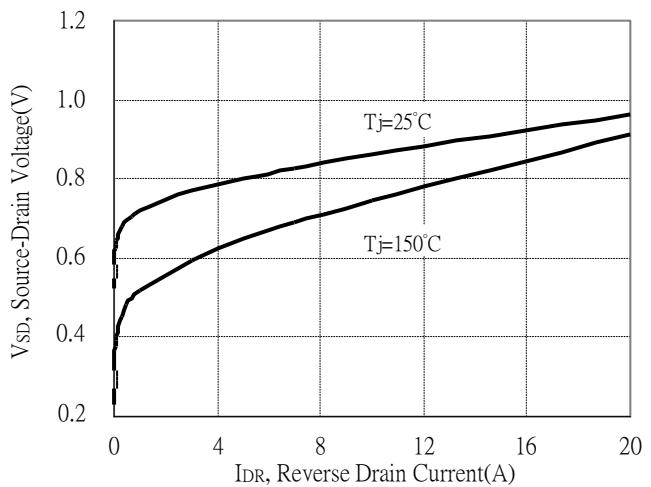
Breakdown Voltage vs Ambient Temperature



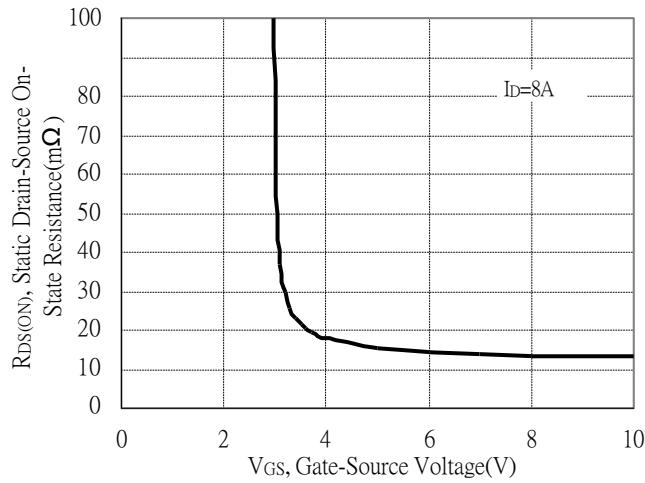
Static Drain-Source On-State resistance vs Drain Current



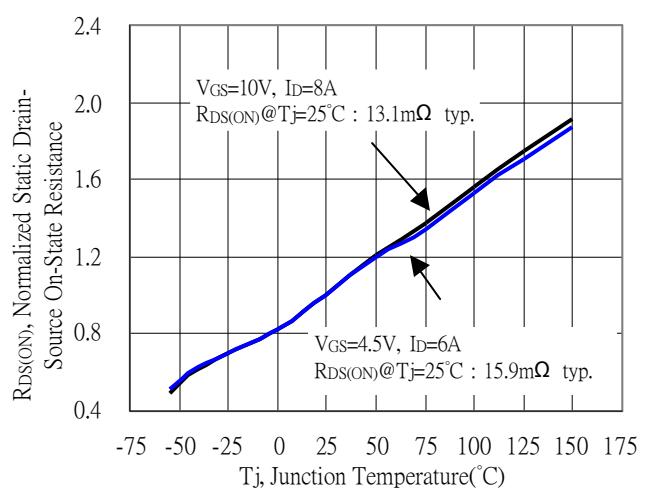
Reverse Drain Current vs Source-Drain Voltage



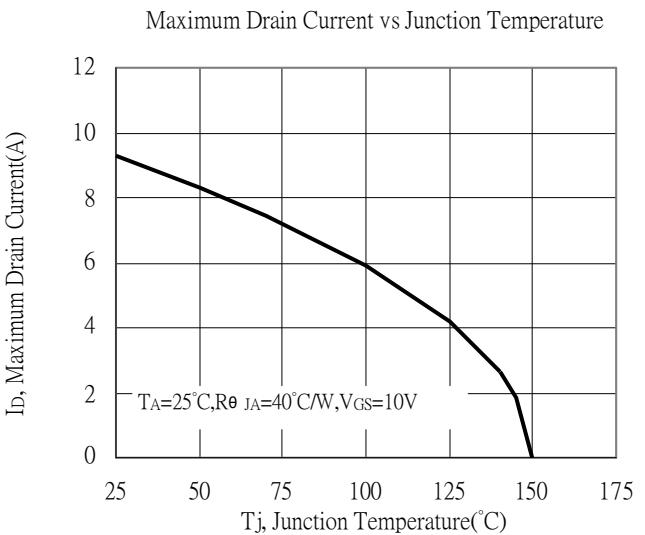
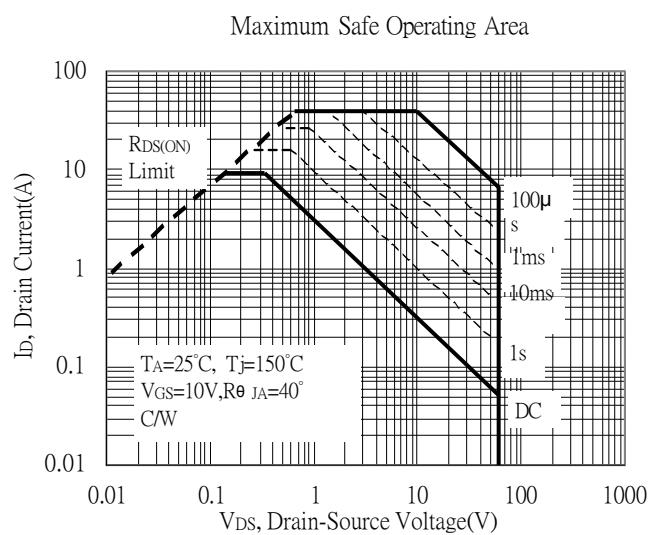
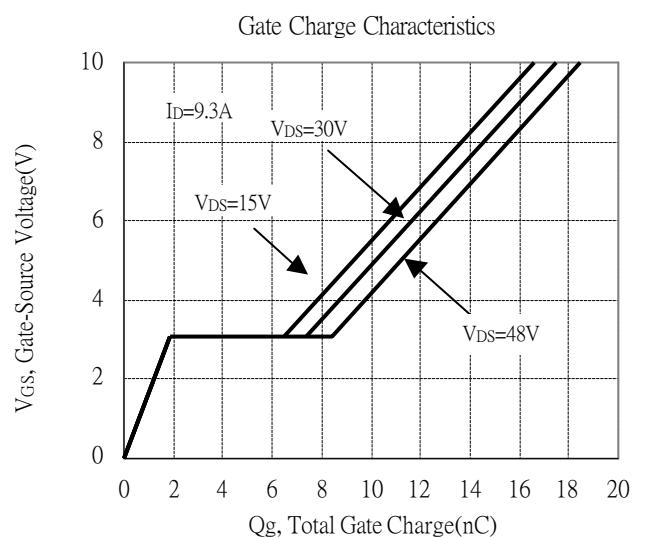
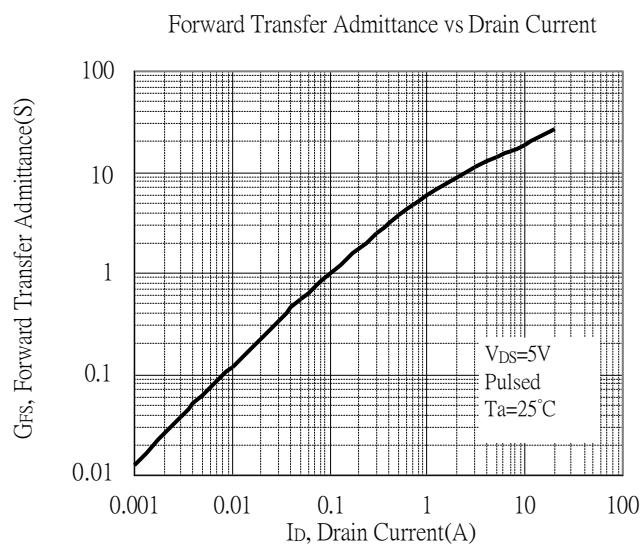
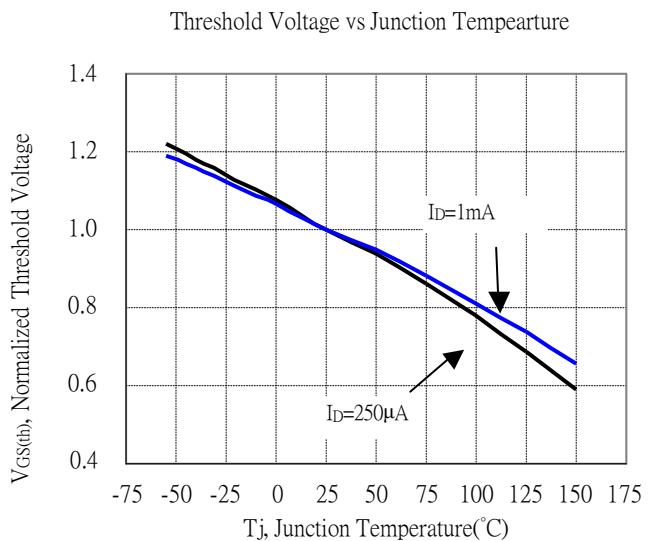
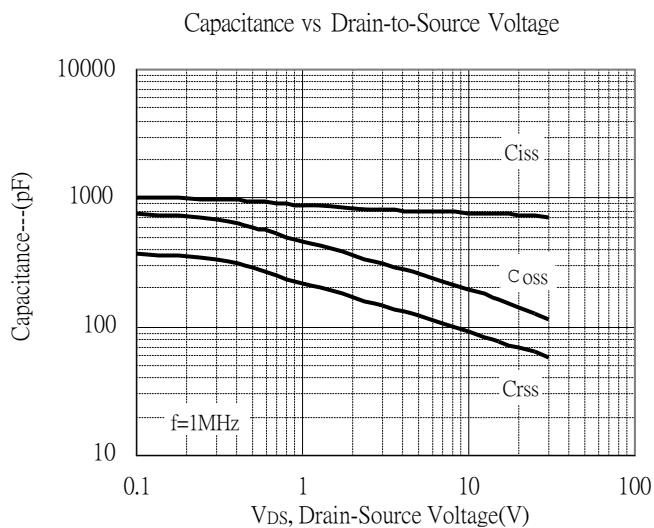
Static Drain-Source On-State Resistance vs Gate-Source Voltage



Drain-Source On-State Resistance vs Junction Temperature

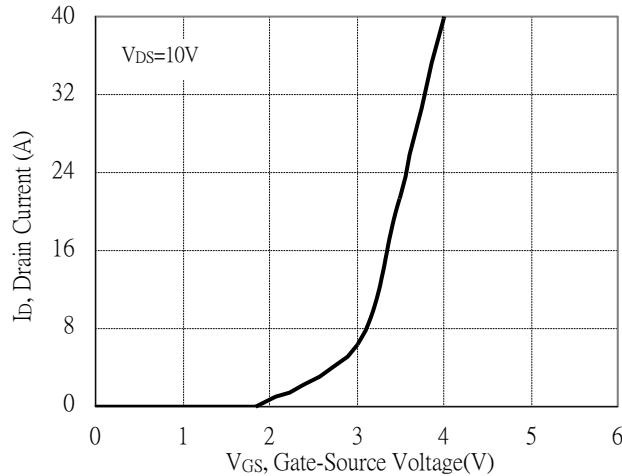


Typical Characteristics(Cont.)

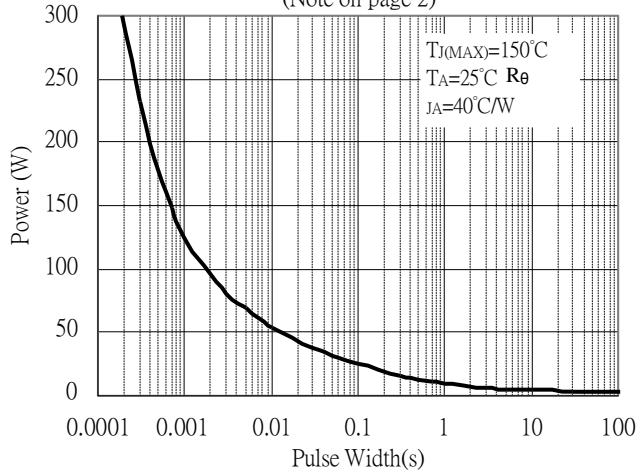


Typical Characteristics(Cont.)

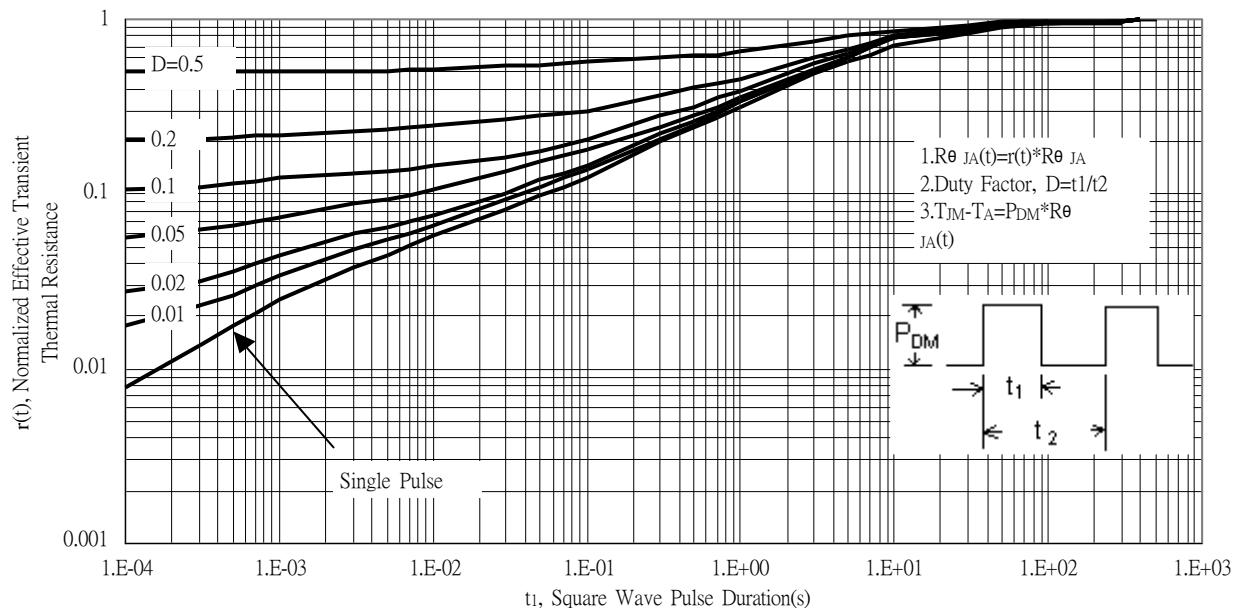
Typical Transfer Characteristics



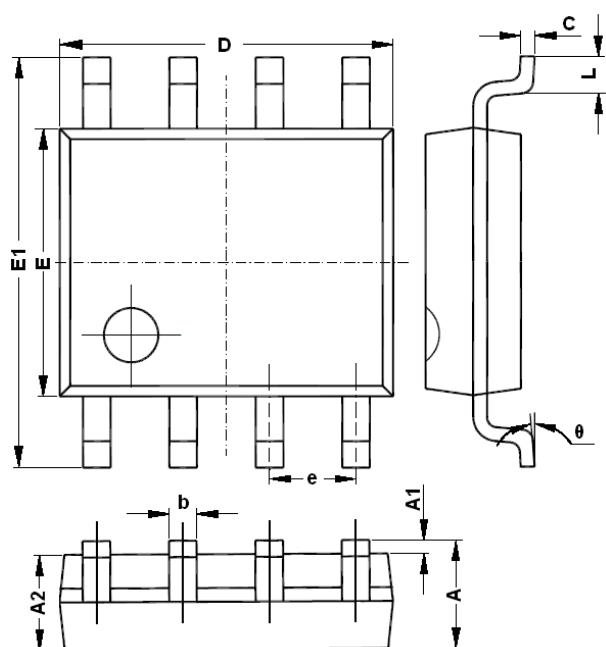
Single Pulse Power Rating, Junction to Ambient
 (Note on page 2)



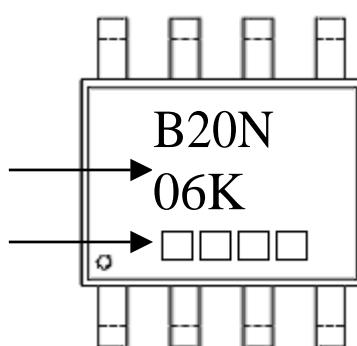
Transient Thermal Response Curves



SOP-8 Dimension



Marking:



8-Lead SOP-8 Plastic Package
 Code: Q8

DIM	Millimeters		Inches		DIM	Millimeters		Inches	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	1.350	1.750	0.053	0.069	E	3.800	4.000	0.150	0.157
A1	0.100	0.250	0.004	0.010	E1	5.800	6.200	0.228	0.244
A2	1.350	1.550	0.053	0.061	e	1.270 (BSC)		0.050	(BSC)
b	0.330	0.510	0.013	0.020	L	0.400	1.270	0.016	0.050
c	0.170	0.250	0.006	0.010	θ	0	8°	0	8°
D	4.700	5.100	0.185	0.200					